

## CD2767BE TECHNICAL DESCRIPTION

This unit is powered by an AC-DC converter with 120V AC input. After some necessary regulator circuits, then distribute the power supply to MCU (IC3 NF2532), CD system (IC1, IC7, IC13), Bluetooth Module (WLIS04), FM tuner (IC12 RDA5807M), Volume control IC (IC9 TDA7440D), Power amplifier (IC4 TAS5611), and USB charger (Q702 ME2325) respectively. 8.4672MHz crystal (X3) is clock for digital audio while two 32.768kHz crystals (X1, X4) are for MCU (IC3) and FM tunerr (IC12).

### **CD mode:**

When starting up the unit, the software defaults to CD function. MCU issues a Command to start up CD and go into CD mode, also enables the Volume Control IC to work in CD Channel, through CD Mechanism to read and get the data of CD R/RW Disc, and after data processing by MCU, output L&R channel audio signals, and performing volume and EQ control by Volume Control IC, then output to Power Amplifier for amplifying the audio signal and drive the external Speakers.

### **Radio mode:**

Input MCU command by Keyboard and turn to Radio Receiver, and turn on the power supply of Radio Receiver, also enables the Volume Control IC to work in Radio Channel. The clock frequency of Radio Receiver is 32.768kHz.

It will convert the radio high frequency signals was received into audio signals, and output through the Radio channel of Volume Control IC, then via Power Amplifier to the external Speakers.

### **Bluetooth mode: (WLIS04)**

16MHz crystal (X1) provides clock for Bluetooth RF IC (U1 IS1681S). U2 (24C32) is serial EEPROM for parameter backup of Bluetooth RF IC (U1 IS1681S).

Input MCU command by Keyboard, switch to Bluetooth mode, and enables MCU to issue a Command to start up the Bluetooth Module, Volume control IC, power supply of the Power amplifier, and make Volume control IC turn to work in Bluetooth Channel. The Bluetooth Module use a PCB antenna, the clock frequency is 16MHz, and works in the band of 2.4GHz, within the frequency range of 2.402GHz ~ 2.480GHz, Modulation type is GFSK, Modulation type is GFSK. The Bluetooth Module will demodulate the Bluetooth RF signals into to Audio signals, and output to the Power Amplifier for amplifying through the Bluetooth Channel of Volume Control IC, and then drives the Speakers by the Amplifier.

### **Aux mode:**

Input the command into the MCU by keyboard, and switch to AUX mode.

External Audio signal input to Volume Control IC via 3.5MM Jack for volume and EQ control, and output Audio Signal to Power Amplifier for amplifying, and then drives the Speakers by the Amplifier.

### **USB Changer:**

Supply 5V from AC/DC converter, and charge to the external device through USB 2.0 Jack.

**BlueTooth Module**

**Modulation Type: GFSK**

**Antenna Type: Integral, Internal (PCB Trace)**

**Frequency Range: 2402MHz - 2480MHz, 1MHz channel spacing, 79 channels**

**Antenna Gain: 0dBi**

**Nominal rated field strength: 100.6dB $\mu$ V/m at 3m**

**Maximum allowed field strength of production tolerance: +/- 3dB**

Channel Frequency Table of Bluetooth Module

| CH. NO. | FRE.    | Hex Value |
|---------|---------|-----------|---------|---------|-----------|---------|---------|-----------|---------|---------|-----------|
| CH0     | 2402MHz | 0         | CH26    | 2428MHz | 1A        | CH52    | 2454MHz | 34        | CH78    | 2480MHz | 4E        |
| CH1     | 2403MHz | 1         | CH27    | 2429MHz | 1B        | CH53    | 2455MHz | 35        |         |         |           |
| CH2     | 2404MHz | 2         | CH28    | 2430MHz | 1C        | CH54    | 2456MHz | 36        |         |         |           |
| CH3     | 2405MHz | 3         | CH29    | 2431MHz | 1D        | CH55    | 2457MHz | 37        |         |         |           |
| CH4     | 2406MHz | 4         | CH30    | 2432MHz | 1E        | CH56    | 2458MHz | 38        |         |         |           |
| CH5     | 2407MHz | 5         | CH31    | 2433MHz | 1F        | CH57    | 2459MHz | 39        |         |         |           |
| CH6     | 2408MHz | 6         | CH32    | 2434MHz | 20        | CH58    | 2460MHz | 3A        |         |         |           |
| CH7     | 2409MHz | 7         | CH33    | 2435MHz | 21        | CH59    | 2461MHz | 3B        |         |         |           |
| CH8     | 2410MHz | 8         | CH34    | 2436MHz | 22        | CH60    | 2462MHz | 3C        |         |         |           |
| CH9     | 2411MHz | 9         | CH35    | 2437MHz | 23        | CH61    | 2463MHz | 3D        |         |         |           |
| CH10    | 2412MHz | A         | CH36    | 2438MHz | 24        | CH62    | 2464MHz | 3E        |         |         |           |
| CH11    | 2413MHz | B         | CH37    | 2439MHz | 25        | CH63    | 2465MHz | 3F        |         |         |           |
| CH12    | 2414MHz | C         | CH38    | 2440MHz | 26        | CH64    | 2466MHz | 40        |         |         |           |
| CH13    | 2415MHz | D         | CH39    | 2441MHz | 27        | CH65    | 2467MHz | 41        |         |         |           |
| CH14    | 2416MHz | E         | CH40    | 2442MHz | 28        | CH66    | 2468MHz | 42        |         |         |           |
| CH15    | 2417MHz | F         | CH41    | 2443MHz | 29        | CH67    | 2469MHz | 43        |         |         |           |
| CH16    | 2418MHz | 10        | CH42    | 2444MHz | 2A        | CH68    | 2470MHz | 44        |         |         |           |
| CH17    | 2419MHz | 11        | CH43    | 2445MHz | 2B        | CH69    | 2471MHz | 45        |         |         |           |
| CH18    | 2420MHz | 12        | CH44    | 2446MHz | 2C        | CH70    | 2472MHz | 46        |         |         |           |
| CH19    | 2421MHz | 13        | CH45    | 2447MHz | 2D        | CH71    | 2473MHz | 47        |         |         |           |
| CH20    | 2422MHz | 14        | CH46    | 2448MHz | 2E        | CH72    | 2474MHz | 48        |         |         |           |
| CH21    | 2423MHz | 15        | CH47    | 2449MHz | 2F        | CH73    | 2475MHz | 49        |         |         |           |
| CH22    | 2424MHz | 16        | CH48    | 2450MHz | 30        | CH74    | 2476MHz | 4A        |         |         |           |
| CH23    | 2425MHz | 17        | CH49    | 2451MHz | 31        | CH75    | 2477MHz | 4B        |         |         |           |
| CH24    | 2426MHz | 18        | CH50    | 2452MHz | 32        | CH76    | 2478MHz | 4C        |         |         |           |
| CH25    | 2427MHz | 19        | CH51    | 2453MHz | 33        | CH77    | 2479MHz | 4D        |         |         |           |

**Features:****Bluetooth 3.0+EDR Stereo Audio module**

- Bluetooth 3.0+EDR compliant
- Typical +2dBm Class 2 output power
- Receiver Sensitivity: GFSK typical -91dBm, π/4 PSK typical -92dBm, 8DPSK typical -84dBm
- Audio DAC: 94dB SNR
- Build in Max. 250mAH Li-ion battery charging circuit
- HSP, A2DP, AVRCP profile support
- SBC decode for Bluetooth audio streaming
- Voice prompt
- Build in Line in interface
- NFC support
- EQ control
- Size: 23mm x 14mm



Jan 2013

**Product Description:**

The WLIS04-ST is a highly integrated Bluetooth 3.0+EDR stereo module, designed for high data rate, short-range wireless communication in the 2.4 GHz ISM band. With ISSC Bluetooth stack and profile, the WLIS04-ST provides a low power and ultra-low cost Bluetooth 3.0+EDR solution for wireless voice/audio applications.

**Applications:**

- High quality stereo speaker and HiFi
- High quality wireless stereo audio receiver

**Outline Dimension & Pin Definition:**

| Pin No. | I/O | Name    | Description   |
|---------|-----|---------|---|
| 1       | P   | P30     | GPIO, default pull-high input<br>Line-in detection, 1: no line-in detected; 0: line-in detected |
| 2       | I/O | P20     | GPIO, default pull-high input<br>System Configuration, H: Application; L: Baseband(IBDK Mode)   |
| 3       | I/O | P00     | GPIO, default , pull-low input. Slide Switch Detector   |
| 4       | I/O | P04     | GPIO, default pull-high input<br>Audio AMP Enable/NFC detect                                    |
| 5       | AO  | SPKR    | R-channel analog headphone output, single-ended application only                                |
| 6       | AO  | AOHPM   | Headphone common mode output/sense input  |
| 7       | AO  | SPKL    | L-channel analog headphone output, single-ended application only                                |
| 8       | P   | VDDAO   | Positive power supply dedicated to CODEC output amplifiers                                      |
| 9       | P   | GND     | Ground  |
| 10      | NC  |         |   |
| 11      | NC  |         |   |
| 12      | NC  |         |   |
| 13      | AI  | AIR     | Stereo analog line in, R-channel  |
| 14      | AI  | AIL     | Stereo analog line in, L-channel  |
| 15      | I/O | RST_N   | System Reset Pin  |
| 16      | P   | GND     | Ground  |
| 17      | P   | ADAP_IN | Power adaptor input   |
| 18      | P   | BAT_IN  | Battery input   |
| 19      | P   | SYS_PW  | System Power Output   |
| 20      | I/O | SK1/P35 | Default SAR input for battery detection<br>This pin can be re-defined as GPIO3_5                |
| 21      | P   | BK_OUT  | Buck feedback sense pin   |
| 22      | P   | GND     | Ground  |
| 23      | P   | MFB     | Multi-Function Push Button key<br>Combined Play/Pause key when A2DP enabled.                    |
| 24      | P   | LED1    | LED Driver 1  |
| 25      | P   | LED2    | LED Driver 2  |
| 26      | I/O | P02     | GPIO, default pull-high input<br>PLAY/PAUSE button  |



|    |     |         |   |
|----|-----|---------|---|
| 27 | I/O | P27     | GPIO, default pull-high input<br>Foward button      |
| 28 | I/O | P05     | GPIO, default pull-high input<br>REW button         |
| 29 | O   | HCI_TXD | HCI TX data   |
| 30 | I   | HCI_RXD | HCI RX data   |
| 31 | I/O | P16     | GPIO, default pull-high input<br>Volume down button |
| 32 | I/O | P01     | GPIO, default pull-high input<br>Volume up button   |
| 33 | I/O | P03     | GPIO, default pull-high input, RX_IND               |
| 34 | P   | GND     | Ground  |

**Electrical Characteristics:****Absolute Maximum Ratings**

| Rating                |  | Min   | Max   | Max |
|-----------------------|--|-------|-------|-----|
| Operation Temperature |  | -20°C | +70°C | °C  |
| Core supply voltage   | VDD_CORE, VCC_RF,<br>AVDD_SAR,<br>AVDD_PLL | 1.7V  | 1.98V | V   |
| Codec supply voltage  | VDD_AUDIO                                  |       | 3.3   | V   |
| I/O voltage           | VDD_IO                                     |       | 3.3   | V   |
| Supply voltage        | BK_VDD                                     |       | 4.7   | V   |
|                       | 3V1_VIN                                    |       | 5     | V   |
|                       | BAT_IN                                     |       | 4.3   | V   |
|                       | ADAP_IN                                    |       | 6     | V   |
|                       | LED[1:0]                                   |       | 5     | V   |
|                       | Power switch                               |       | 6     | V   |

**Recommended Operate Condition:**

| Symbol          | Parameter                   | Min. | Typical | Max  | Unit |
|-----------------|-----------------------------|------|---------|------|------|
| $V_{DD18}$      | Digital core supply voltage |      |         |      |      |
|                 | SAR ADC supply voltage      | 1.62 | 1.8     | 1.92 | V    |
|                 | CODEC supply voltage        |      |         |      |      |
| $V_{DDIO}$      | I/O supply voltage          |      |         |      |      |
|                 | RF supply voltage           | 2.5  | 2.7     | 3.3  | V    |
| $T_{OPERATION}$ | Operating temperature range | -20  | +25     | +70  | °C   |
| $T_{stg}$       | Storage temperature         | -40  |         | +125 | °C   |
| $V_{LDO}$       | LDO supply voltage          | 1.8  |         | 3.3  | V    |
| $V_{BAT\_IN}$   | Input voltage for SAR ADC   | 0.9  |         | 3.3  | V    |

**Audio DAC:**

| Test Condition: T= 25°C, Vdd=2.8V, 1KHz sine wave input, Bandwidth= 20~20KHz |  |         |      |      |      |      |
|--|--|---------|------|------|------|------|
| Parameter  | Condition  |         | Min. | Typ. | Max. | Unit |
| Output Level   | Full scale   |         |      | 2.1  |      | Vpp  |
| Resolution   |  |         | 16   |      |      | bits |
| Output Sampling Rate   |  |         | 8    |      | 48   | KHz  |
| SNR  | $f_{in}=1\text{KHz}$<br>$B/W=20\text{~}20\text{KHz}$<br>A-weighted<br>$THD+N < 0.01\%$<br>0dBFS signal<br>Load=100KΩ | 8Khz    |      | 94   |      | dB   |
|  |  | 16Khz   |      | 94   |      | dB   |
|  |  | 32Khz   |      | 94   |      | dB   |
|  |  | 44.1Khz |      | 94   |      | dB   |
|  |  | 48Khz   |      | 94   |      | dB   |
|  |  |         |      |      |      |      |
| Max Output Power   | $R_L=16\text{Ohm}$   |         |      | 35   |      | mW   |
|  | $R_L=32\text{Ohm}$   |         |      | 17   |      | mW   |



|                              |   |     |     |      |     |
|------------------------------|---|-----|-----|------|-----|
| THD+N                        | 16Ohm load                              |     |     | 0.05 | %   |
|                              | 100KΩ load                              |     |     | 0.01 | %   |
| Digital Gain                 |   | -54 |     | 4.85 | dB  |
| Digital Gain Resolution      |   |     | 6   |      | dB  |
| Analog Gain                  |   | -28 |     | 3    | dB  |
| Analog Gain step             |   |     | 1   |      | dB  |
| Output resistance            | R <sub>L</sub>                          | 8   | 16  |      | Ohm |
| Output capacitance           | C <sub>p</sub>                          |     |     | 500  | pF  |
| Crosstalk between channels   | L vs. R, measured at -10dBFS@1KHz input |     | -90 | -80  | dB  |
| Analog supply voltage (AVDD) |   | 1.8 | 2.8 | 3.0  | V   |

**Battery Charger:**

| Charging Mode (BAT_IN rising to 4.2V)   | Min             | Typ   | Max | Unit |
|---|-----------------|-------|-----|------|
| Operation Temperature   | -20             |       | 70  | °C   |
| Input Voltage (Vin)   |                 |       |     |      |
| Note: It needs more time to get battery fully charged when Vin=4.5V           | 4.5             |       | 6   | V    |
| Battery trickle charge current<br>(BAT_IN < trickle charge voltage threshold) |                 | 0.1C  |     | mA   |
| Trickle charge voltage threshold  |                 | 3     |     | V    |
| Maximum battery charge current  | Headroom > 0.7V |       | 350 | mA   |
|   | Headroom = 0.3V |       | 150 | mA   |
| Minimum battery charge current  | Headroom > 0.7V |       | 1   | mA   |
|   | Headroom = 0.3V |       | 1   | mA   |
| Battery charge termination current,<br>% of fast charge current               |                 | 10    |     | %    |
| Battery recharge hysteresis (Note1)   |                 | 100   |     | mV   |
| Battery recharge current (Note2)  |                 | 0.25C |     | mA   |
| Note: C → Battery capacity  |                 |       |     |      |



Note1: When charging complete and the adapter is still in, the battery voltage will slowly drop down.

when the voltage drop is larger than 100mV from the full voltage, the re-charging cycle will start.

Note2: If the battery voltage during plug in is larger than 4V, the charging current will be limited to 0.25C

to avoid the battery voltage overshoot.

## FCC ID:

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

(1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

## BQB:

### The Bluetooth SIG Hereby Recognizes

**WLINK TECHNOLOGY (HK) CO., LIMITED**

Member Company

Audio BT module

Qualified Design Name

Qualified Design ID(s): B020890

Specification Name: 3.0

Product Type: End Product

Model Number: WLIS04-ST

BQE Name: Totti Huang

Listing Date: 24 April 2013

Assessment Date: 24 April 2013

Hardware Version Number: V2

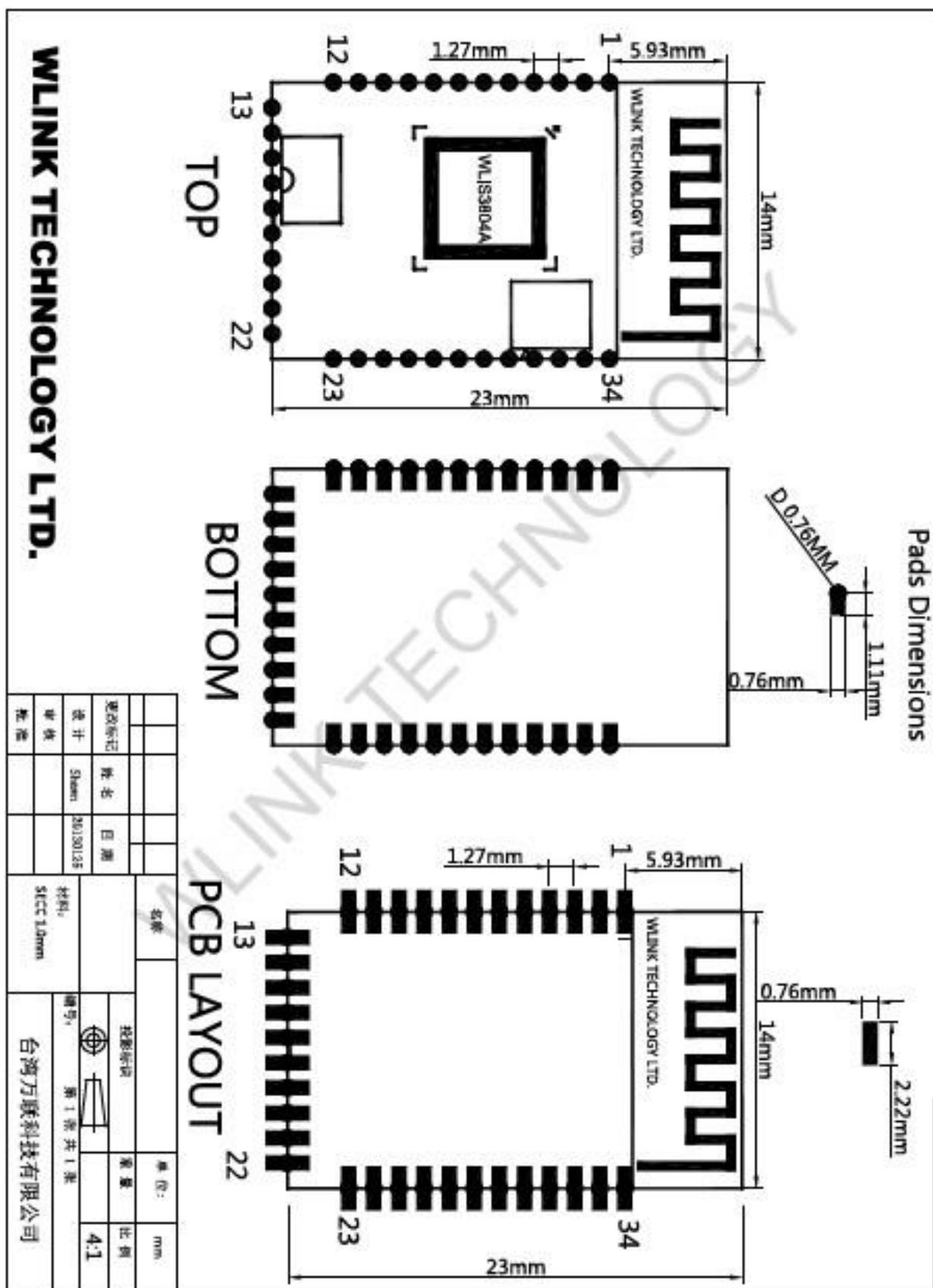
Software Version Number: V2

This certificate acknowledges the *Bluetooth*® Specifications declared by the member were achieved in accordance with the *Bluetooth* Qualification Process as specified within the *Bluetooth* Specifications and as required within the current PRD





## Mechanical specification:



## Bluetooth 3.0+EDR Multimedia SOC

### 1. General Description

ISSC IS1681S is a compact, high integration, ultra-low cost, CMOS single-chip RF + baseband IC for Bluetooth v3.0+EDR (Enhanced Data Rate) 2.4GHz applications. This chip is fully compliant with Bluetooth specification and completely backward-compatible with Bluetooth 1.1, 1.2, 2.0 or 2.1 systems.

It incorporates Bluetooth 1M/2M/3Mbps RF, single-cycle 8051, TX/RX modem, memory controller, task/hopping controller, UART interface, and ISSC Bluetooth software stack to achieve the required Bluetooth v3.0+EDR functions.

The IS1681S is designed to support high quality audio applications, an audio engine and a high performance stereo CODEC are integrated for this purpose.

The audio engine provides the A-law/μ-law/CVSD voice encoding/decoding and also the SBC audio decoding. Handed noise reduction and echo cancellation to offer the best voice quality in the both sending and receiving sides.

In addition, to minimize the external components required for portable devices, a voltage sensor for battery, Li-ion battery charger, a switching regulator and LDOs are integrated to reduce BOM cost for various Bluetooth applications.

The device incorporates built-in self-test (BIST) and auto-calibration functions to simplify production test.

## 2. Features

### System Specification

- Compliant with Bluetooth Specification v.3.0 + EDR in 2.4 GHz ISM band

### Baseband Hardware

- 16MHz main clock input
- Built-in internal ROM for program memory
- Built-in 32 KB RAM for data storage and baseband data transfer buffering
- Enhanced Power Control
- Bluetooth 2.1 features
  - Encryption Pause and Resume
  - Erroneous Data Reporting
  - Extended Inquiry Response
  - Link Supervision Timeout Changed Event
  - Non-Flushable Packet Boundary Flag
  - Secure Simple Pairing
  - Sniff Subtracting
- Support both Pico-net and Scatter-net applications
- Hard-wired logic for modulation, demodulation, access code correlation, whitening, forward error correction (FEC), header error check (HEC), shorten hamming code, CRC generation/checking, frame check sequence (FCS), encryption bit stream generation, and transmit pulse shaping
- Adaptive Frequency Hopping (AFH) avoids occupied RF channels

- Fast Connection supported

#### **RF Hardware**

- Fully Bluetooth 3.0 + EDR system in 2.4 GHz ISM band.
- Combined TX/RX RF terminal simplifies external matching and reduces external antenna switches.
- Max. +4dBm output power with 20 dB level control from register control.
- Build-in T/R switch for Class 2/3 application
- Build-in channel filter.
- To avoid temperature variation, temperature sensor with temperature calibration is utilized into bias current and gain control.
- Fully integrated synthesizer has been created. There requires no external VCO, varactor diode, resonator and loop filter.
- Crystal oscillation with build-in digital trimming for temperature/process variations.

#### **Audio processor**

- Support 64 kb/s A-Law or  $\mu$ -Law PCM format, or CVSD (Continuous Variable Slope Delta Modulation) for SCO channel operation.
- Noise suppression
- Echo suppression
- SBC decoding
- Packet error concealment

#### **Audio Codec**

- 16 bit stereo codec

- 94dB SNR DAC playback
- Integrate headphone amplifier for 16Ω speakers

### **Peripherals**

- Built-in Lithium-ion battery charger
- Integrate 3V, 1.8V LDO and Switching mode regulator
- Built-in 10-bit Aux-ADC for battery monitor and voltage sense.
- LED driver

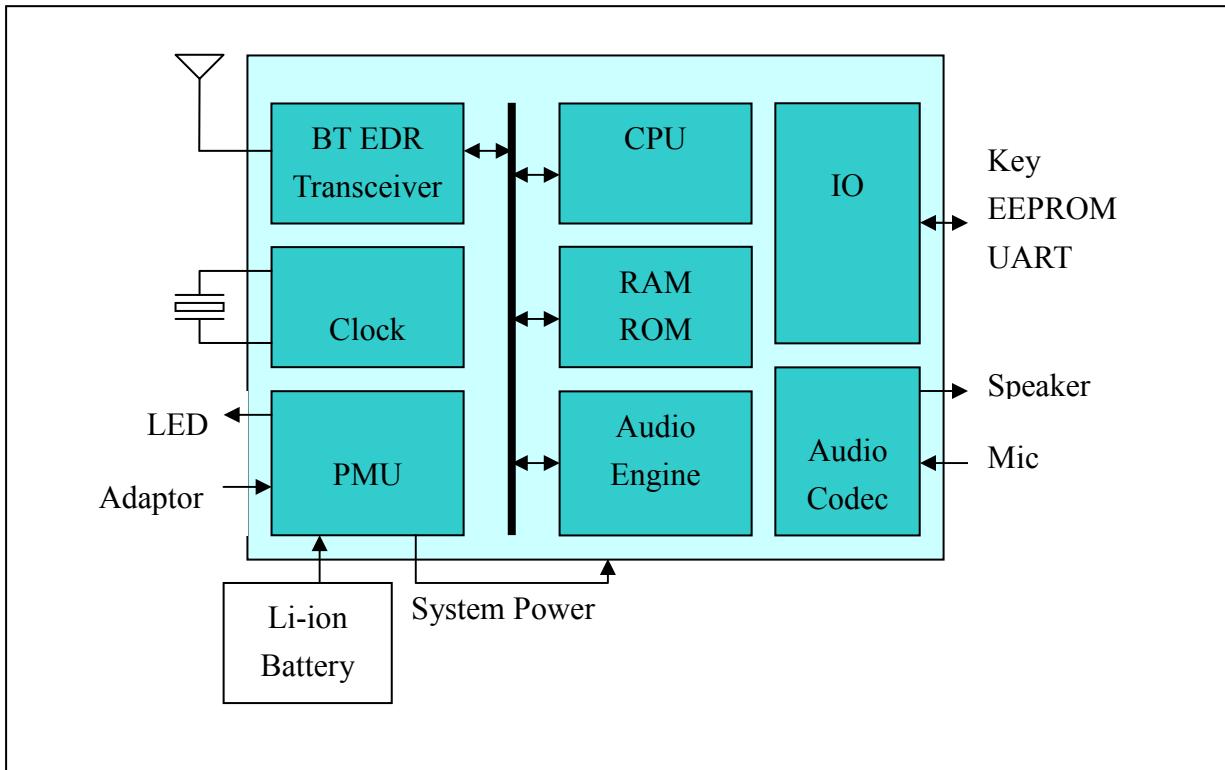
### **Flexible HCI interface**

- High speed HCI-UART (Universal Asynchronous Receiver Transmitter) interface

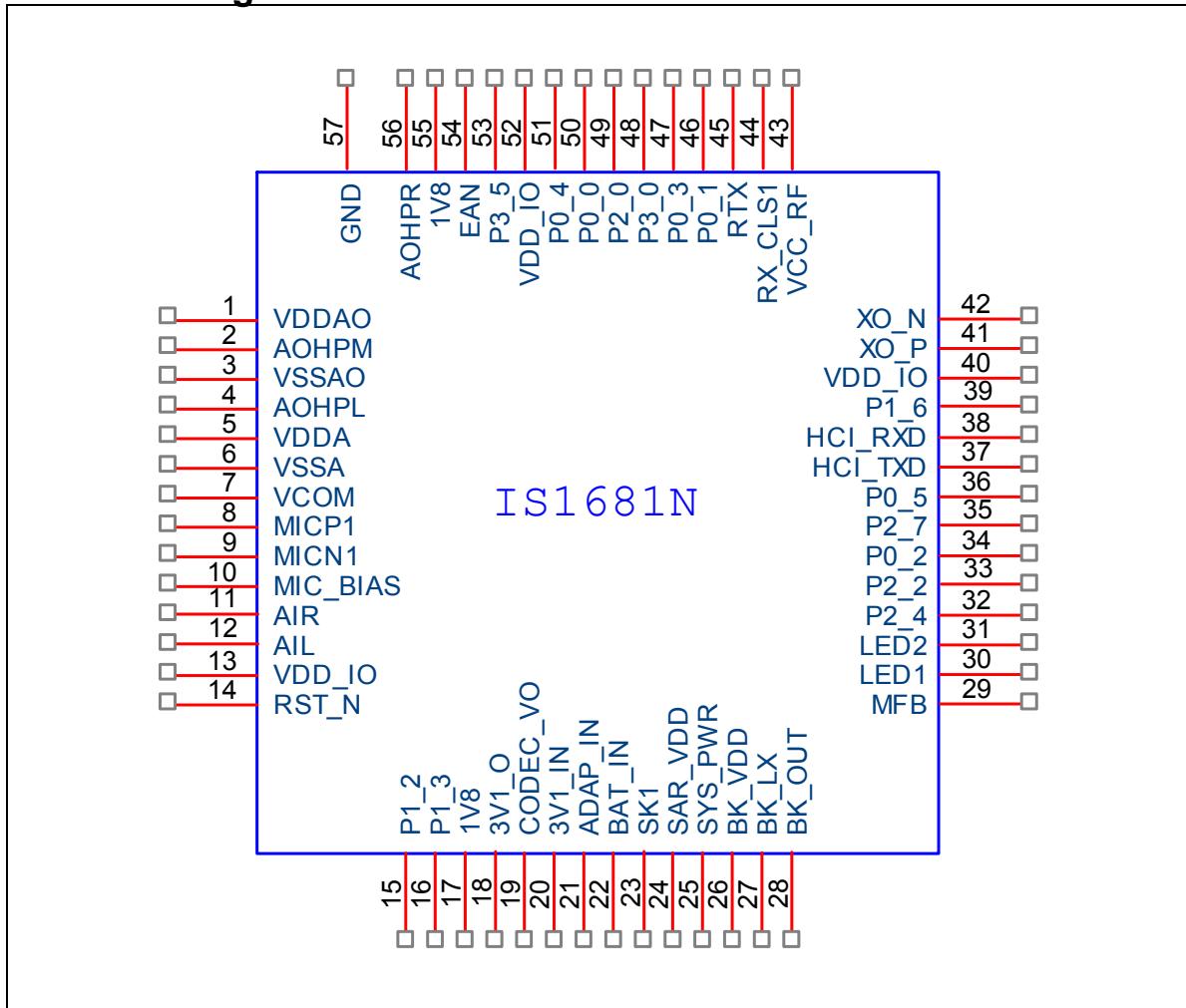
### **Package**

- 7x7mm<sup>2</sup> 56 pins, 0.4mm pitch SAW QFN standard package

### 3. Functional Diagram



#### 4. Pin Assignment



## 5 Pin Descriptions

| Pin No. | I/O | Pin Name | Pin Descriptions  |
|---------|-----|----------|---|
| 1       | P   | VDDAO    | Positive power supply dedicated to CODEC output amplifiers.                                       |
| 2       | AO  | AOHPM    | Headphone common mode output/sense input  |
| 3       | P   | VSSAO    | Negative power supply dedicated to CODEC output amplifiers  |
| 4       | AO  | AOHPL    | L-channel analog headphone output   |
| 5       | P   | VDDA     | Positive power supply/reference voltage for CODEC   |
| 6       | P   | VSSA     | Negative reference/power supply for CODEC   |
| 7       | AO  | VCOM     | Internal biasing voltage for CODEC  |
| 8       | AI  | MICP1    | Mic 1 mono differential analog positive input   |
| 9       | AI  | MICN1    | Mic 1 mono differential analog negative input   |
| 10      | P   | MIC_BIAS | Electric microphone biasing voltage   |
| 11      | AI  | AIR      | R-channel single-ended analog inputs  |
| 12      | AI  | AIL      | L-channel single-ended analog inputs  |
| 13      | P   | VDD_IO   | I/O power supply input  |
| 14      | AI  | RST_N    | KEY PIN for FT Test<br>System Reset Pin   |
| 15      | I/O | P1_2     | GPIO, default pull-high input<br>KEY PIN for FT Test<br>EEPROM clock SCL<br>Clock signal for OLED |
| 16      | I/O | P1_3     | GPIO, default pull-high input<br>KEY PIN for FT Test<br>EEPROM data SDA<br>Data signal for OLED   |
| 17      | P   | 1V8      | Core 1.8V power input   |
| 18      | P   | 3V1_O    | 3.1V LDO output   |
| 19      | P   | CODEC_VO | 3.1V LDO output for CODEC power   |
| 20      | P   | 3V1_VIN  | 3.1V LDO input  |
| 21      | P   | ADAP_IN  | Power adaptor input   |
| 22      | P   | BAT_IN   | Battery input   |

| Pin No. | I/O | Pin Name | Pin Descriptions  |
|---------|-----|----------|---|
| 23      | AI  | SK1      | ADC analog input 1  |
| 24      | P   | SAR_AVDD | SAR 1.8V input  |
| 25      | P   | SYS_PWR  | System Power Output   |
| 26      | P   | BK_VDD   | Buck VDD Power Input  |
| 27      | P   | BK_LX    | Buck feedback input   |
| 28      | P   | BK_OUT   | Buck output   |
| 29      | P   | MFB      | Multi-Function Push Button key, push high   |
| 30      | AI  | LED1     | LED Driver 1  |
| 31      | AI  | LED2     | LED Driver 2  |
| 32      | I/O | P2_4     | GPIO, default pull-high input<br>KEY PIN for FT Test<br>System Configuration, H: Boot Mode                              |
| 33      | I/O | P2_2     | GPIO, default pull-low input.<br>Keep alive for external LDO power enable application.                                  |
| 34      | I/O | P0_2     | GPIO, default pull-high input<br>Play/Pause key as the default setting  |
| 35      | I/O | P2_7     | GPIO, default pull-high input<br>FWD key when class 2 RF<br>FWD key(short press) when class 1 RF                        |
| 36      | I/O | P0_5     | GPIO, default pull-high input<br>KEY PIN for FT Test<br>REV key when class 2 RF<br>REV key(short press) when class 1 RF |
| 37      | O   | HCI_TXD  | KEY PIN for FT Test<br>HCI TX data  |
| 38      | I   | HCI_RXD  | KEY PIN for FT Test<br>HCI RX data  |
| 39      | I/O | P1_6     | GPIO P1_6, default pull-high input<br>Volume down key when class 2 RF<br>Audio AMP Enable when class 1 RF               |
| 40      | P   | VDD_IO   | I/O power supply input  |
| 41      | I   | XO_P     | 16MHz Crystal input positive  |

| Pin No. | I/O | Pin Name  | Pin Descriptions   |
|---------|-----|-----------|--|
| 42      | I   | XO_N      | 16MHz Crystal input negative   |
| 43      | RP  | VCC_RF    | RF power input for both synthesizer and TX/RX block  |
| 44      | I   | RX_CLASS1 | Class1 RF RX path  |
| 45      | I/O | RTX       | Class2 RTX path; Class1/Class2 TX path   |
| 46      | I/O | P0_1      | GPIO, default pull-high input<br>Volume up key when class 2 RF.<br>Class1 Control signal of external TR switch when class 1 RF |
| 47      | I/O | P0_3      | GPIO, default pull-high input<br>KEY PIN for FT Test<br>Class1 Control signal of external TR switch when class 1 RF            |
| 48      | I/O | P3_0      | GPIO, default pull-high input<br>Reverved charger LED driver   |
| 49      | I/O | P2_0      | GPIO, default pull-high input<br>KEY PIN for FT Test<br>System Configuration, H: Application L:<br>Baseband(IBDK Mode)         |
| 50      | I/O | P0_0      | GPIO, default pull-low input.<br>KEY PIN for FT Test<br>Slide Switch Detector  |
| 51      | I/O | P0_4      | GPIO, default pull-high input<br>Audio AMP Enable when class 2 RF  |
| 52      | P   | VDD_IO    | I/O power supply input   |
| 53      | I/O | P3_5      | GPIO 3_5, default pull-high input.<br>Buzzer Signal Output   |
| 54      | I   | EAN       | Embedded ROM/External Flash enable<br>H: Embedded; L: External Flash   |
| 55      | P   | 1V8       | Core 1.8V power input  |
| 56      | AO  | AOHPR     | R-channel single ended analog headphone output   |
| 57      | P   | GND       | Exposed pad as ground  |

Application Note for GPIO Setting:

- 1) KEY PIN for internal test  
HCl\_RXD, HCl\_TXD, RST\_N, P2\_0, P2\_4, P1\_3, P1\_2, P0\_3, P0\_5, P0\_0
- 2) For Class2 RF application: VOL+:P0\_1, VOL-: P1\_6, FWD:P2\_7, REV:P0\_5, AUDIO AMP ENABLE: P0\_4
- 3) For Class1 RF application: VOL+:P2\_7(Long Press), VOL-: P0\_5(Long Press), FWD:P2\_7(Short Press) , REV: P0\_5(Short Press) , AUDIO AMP ENABLE: P1\_6
- 4) Play/Pause: P0\_2
- 5) P1\_2:EEPROM Clock/Clock Signal for OLED  
P1\_3:EEPROM Data/Data Signal for OLED
- 6) Slide switch detect: P0\_0
- 7) Buzzer Signal Output: P3\_5
- 8) Class 1 RF TX: P0\_1, CLASS 1 RF RX: P0\_3
- 9) External LDO power enable keep alive: P2\_2
- 10) System Configuration: P2\_0, P2\_4

## 6 Functional Description

### 6.1 Overall Architecture

The ISSC IS1681S integrates an enhanced EDR Bluetooth RF & BB core, HCI controller, audio engine and an ENHANCED 8051 processor with an internal mask ROM for program memory and SRAM for data memory. An innovative interconnection structure called the Common-Memory Architecture (CMA) is designed to provide a fast and flexible data movement scheme between the embedded processor, Bluetooth core, and peripheral hardware.

For audio application and power management, IS1681S has build-in an audio processor, mono codec and power management unit to reduce the external components.

### 6.2 Radio Frequency (RF)

#### 6.2.1 Transmitter

The internal PA has a maximum output power of +4dBm with level control 20dB from amplitude control. This is applied into Class 2/3 radios without external RF PA. For Class1 application, the build-in level control can be used with external PA for power control requirement.

The transmitter features IQ direct conversion to minimize the frequency drift. And it can excess 30dB power range with temperature compensation machine.

#### 6.2.2 Receiver

The LNA can be operated into two type modes. One type is TR-combined mode for single port application. The other type is TR-separated mode for external PA/LNA application.

An ADC is used to sample input analogue wave for digital demodulation. Before the ADC, a channel filter has been integrated into receiver channel to increase the anti-interference capacity and also reduce the external component count.

For avoiding temperature variation issues, a temperature sensor with temperature calibration is utilized into bias current and gain control of LNA, Mixers, and RF AMP.

### 6.2.3 Synthesizer

The internal loop filter is used to reduce external RC components. This can reduce cost and variations for components. This internal LC tank for VCO is utilized to reduce variation for components. The cost is down at the same time.

A fully integrated synthesizer has been created. There requires no external VCO, varactor diode, resonator and loop filter.

## 6.3 MODEM

There are three different modulations for Bluetooth v3.0 + EDR. Table 6.3 summarizes these modulations and data rate.

Figure 6.3 Modulation type for Bluetooth v3.0 + EDR

| Data Rate   | Modulation    | Bits/Symbol |
|-------------|---------------|-------------|
| BDR: 1 Mbps | GFSK          | 1           |
| EDR: 2 Mbps | $\pi/4$ DQPSK | 2           |
| EDR: 3 Mbps | 8DPSK         | 3           |

### 6.3.1 **Basic Data Rate MODEM (BDR)**

On the Bluetooth v1.2 specification and below, 1 Mbps was the standard data rate based on Gaussian Frequency Shift Keying (GFSK) modulation scheme. This basic rate modem meets BDR requirements of Bluetooth v3.0+EDR specification.

Figure 6.3.1 Data format for BDR

|             |        |         |
|-------------|--------|---------|
| Access Code | Header | Payload |
|-------------|--------|---------|

### 6.3.2 **Enhanced Data Rate MODEM (EDR)**

On the Bluetooth v3.0+EDR specification, Enhanced Data Rate (EDR) has been introduced to provide 2 and 3 Mbps data rates as well as 1 Mbps. This enhanced data rate modem meets EDR requirements of Bluetooth v3.0+EDR specification. For the viewpoint of baseband, both BDR and EDR utilize the same 1MHz symbol rate and 1.6 KHz slot rate. For BDR, 1 symbol represents 1 bit. However each symbol in the payload part of EDR packets represents 2 or 3 bits. This is achieved by using two different modulations,  $\pi/4$  DQPSK and 8DPSK.

Figure 6.3.2.A Data format for EDR

|             |        |       |      |         |         |
|-------------|--------|-------|------|---------|---------|
| Access Code | Header | Guard | Sync | Payload | Trailer |
|-------------|--------|-------|------|---------|---------|

For  $\pi/4$  DQPSK modulation, each symbol carries 2 bits of information. For its constellation diagram, although there are 8 possible phase states, the encoding scheme guarantees the trajectory of the modulation between symbols is restricted to 4 states. For a given starting

point, every phase change between symbols is restricted to  $+45^\circ$ ,  $+135^\circ$ ,  $-45^\circ$ , and  $-135^\circ$ .

Figure 6.3.2.B Phase shift & bit pattern for 2 MHz data rate

| Phase Shift            | Bit Pattern |
|------------------------|-------------|
| $+45^\circ (+\pi/4)$   | 00          |
| $+135^\circ (+3\pi/4)$ | 01          |
| $-135^\circ (-3\pi/4)$ | 11          |
| $-45^\circ (-\pi/4)$   | 10          |

For 8DPSK modulation, each symbol carries 3 bits of information. For its constellation diagram, it is similar to  $\pi/4$  DQPSK but the trajectory of the modulation between symbols has 8 possible phase states. For a given starting point, every phase change between symbols is restricted to  $0^\circ$ ,  $+45^\circ$ ,  $+90^\circ$ ,  $+135^\circ$ ,  $+180^\circ$ ,  $-135^\circ$ ,  $-90^\circ$ , and  $-45^\circ$ .

Figure 6.3.2.C Phase shift & bit pattern for 3 MHz data rate

| Phase Shift            | Bit Pattern |
|------------------------|-------------|
| $0^\circ (+0)$         | 000         |
| $+45^\circ (+\pi/4)$   | 001         |
| $+90^\circ (+\pi/2)$   | 011         |
| $+135^\circ (+3\pi/4)$ | 010         |
| $+180^\circ (+\pi)$    | 110         |
| $-135^\circ (-3\pi/4)$ | 111         |
| $-90^\circ (-\pi/2)$   | 101         |

|             |     |
|-------------|-----|
| -45° (-π/4) | 100 |
|-------------|-----|

## 6.4 Baseband

The following modules implemented in hardware constitute the Bluetooth Baseband Core. The frequency hopping sequence generator produces the correct hop frequency control sequence based on the Bluetooth clock, Bluetooth device address, and the current operating mode.

The access code generates the access code based on the Lower Address Part (LAP) of the Bluetooth device address. The access code is comprised of the preamble, sync word and trailer bits. The detection of the access code uses correlation to detect a valid access code.

Bluetooth uses two types of FEC: 1/3 repetition code and (15, 10) shorten Hamming code respectively. The former basically repeats each transmitted bit three times while the latter has 15 bits of codeword which contains 5 parity bits. The code has capability of correction of all single-bit errors in each codeword.

The purpose of HEC is to protect the header bits. Dedicated header error code generator calculates the HEC bits in the header of a transmitted packet. While on the receiver side, HEC detects corrupted headers.

A 16-bit CRC is adopted to protect payload data transmitted using certain types of Bluetooth packets.

Information confidentiality can be protected by encryption of the packet payload.

Dedicated encryption/decryption hardware is designed into the baseband core.

## 6.5 MCU

The embedded processor for IS1681S is a single-cycle 8051 CPU. The embedded processor will be referred to as simply the processor, 8051, or MCU throughout the remainder of this document. There are a few minor differences between a standard 8051 and this CPU. These include:

1. Alteration of memory timings to match internal and external memory configurations.
2. Modification of idle mode to disable internal CPU clocking. Only externally-clocked interrupt sources can allow the CPU to recover from idle mode.

A single-port synchronous interface is provided to memory. From this single port, the bandwidth is divided among the 7 interfaces spread amongst 5 physical busses described below:

- Embedded processor bus
- Baseband TX bus
- Baseband RX bus
- HCI TX bus
- HCI RX bus
- Audio bus
- DMA bus

In addition, attached to the embedded processor bus are a register bank, a dedicated single-port memory (data segment 1), and flash memory (program segment). The processor coordinates all link control procedures and data movement using a set of pointer registers. For example, when an HCI packet (from the host via USB or UART) is received into the HCI buffer, the processor is interrupted. The processor can then read a

status register to determine the HCI packet type and determine whether to set up the Baseband pointer registers for this memory region for RF-retransmission, or to otherwise directly perform packet processing with the CPU.

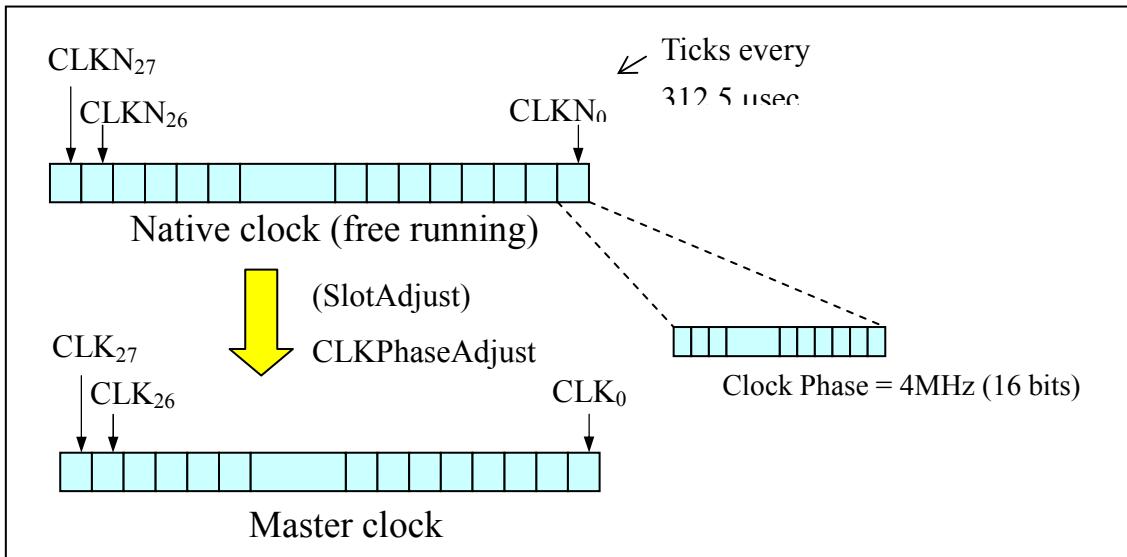
## 6.6 Bluetooth Clock and Timers

A Bluetooth standard 28-bit counter running at 3.2 kHz implements the native clock defined by Bluetooth specification. This clock provides the transmission and receiving timing of a half time slot (312.5  $\mu$ s). Another finer counter implemented in 16 bits is also provided as the phase of a half time slot. This phase information is very helpful when a Bluetooth slave wants to adapt to its master's clock. The counter is pre-scalable for the purpose of power saving operations. The diagram below describes a standard Bluetooth native clock and master clock. The clock signal is also used as a slot boundary signal to trigger a baseband packet transmission or receipt.

There are several timers provided by the system, two timers for TX/RX and the others for general purpose.

The powerful pre-scheduling functions for the transceiver are realized different sets of programmable timers. Each set of timers is associated with the task of transmission or receiving. When the timer is configured by firmware, it will automatically execute the TX or RX task at a specific time. Sub-tasks and timing for a TX task remain to be defined.

Figure 6.6 Bluetooth clock



## 6.7 HCI Control Logic for USB/UART

Hardwired control logic is presented in front of the UART devices for HCI protocol handling and packet buffering. This control logic is part of the HCI controller defined in Bluetooth specification 1.2. This logic is partially responsible for the HCI protocol handling to/from the host and it also maps the registers of the UART devices indirectly to the 8051 such that the system can receive or send a HCI packet to/from the respective host interface. Major functions of this logic include:

- HCI packet formatter and de-formatter (identifying the packet type)
- Frame boundary determination, segmentation and reassembly of HCI packets.
- HCI packet transmission, receiving, and buffering (using common memory HCI buffer).
- Independent receive / transmit channels
- Universal device interface

### **6.7.1 HCI UART Interface**

An embedded HCI UART (Universal Asynchronous Receiver Transmitter) with programmable data rate up to 3Mbps is included in this design. The HCI UART supports the following functions:

- Full-Duplex operation
- Programmable BAUD rate (using 16-bit input clock divider to obtain Baud Rate x16 or x24 or x13 clock base)
- 7 or 8 Data bits
- 1 or 2 Stop bits
- Even / Odd / Mark / Space / None Parity configurations
- Break Generation / Detection
- Maskable individual interrupts to CPU and combined Error interrupt to HCI
- Selectable Direct CPU interface or interface to HCI module

### **6.8 General Purpose I/O**

The IS1681S provides 14 general purpose I/O ports. These general I/Os can be defined as input or output port individually by setting specific register bit. While setting as an input port, a build-in  $50K\Omega$  pull high or pull low resistor can be enabled for different application purpose.

### **6.9 Audio Processor**

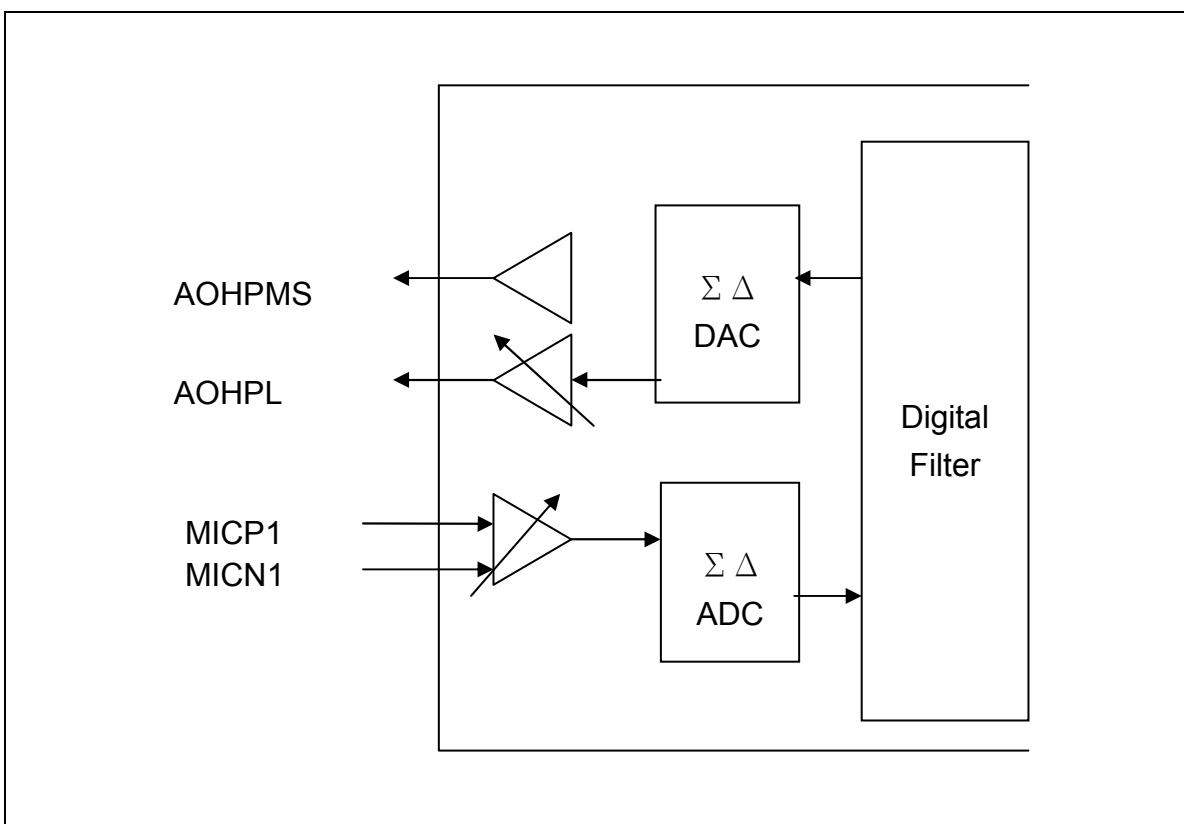
The IS1681S builds in an enhanced audio engine to offer high quality of audio for voice application. The standard A-law/ $\mu$ -law/CVSD voice functions are implemented in the audio engine. The enhanced audio functions, like AEC, noise reduction, can be achieved with

enhanced algorithm.

## 6.10 Audio Codec

The build in codec contains a analog to digital convert (ADC), a digital to analog converter (DAC) and additional analog circuits like headphone driver and microphone amplifier.

Figure 6.10 Audio Codec



### 6.10.1 ADC

The ADC interface supports variety sampling rate from 8k Hz to 48k Hz. The microphone input has 42 dB programmable analog gain and 48db digital gain. A regulated MIC\_Bias is available.

### **6.10.2 DAC**

The DAC output is available for both line level and through the headphone amplifier to drive a low impedance headphone. The headphone output volume is adjustable by the combination of the digital/analog gain control.

### **6.11 Auxiliary ADC**

The 10-bit auxiliary analog to digital converter (SAR ADC) provides one dedicated channel for battery power detection and one other channel for external peripheral sensing. This ADC has 10 bits resolution that provides an accurate monitoring for battery voltage. The operating current is very low and almost consumes no power when disabled.

### **6.12 Power Management (PMU)**

The power management unit of IS1681S includes several power control blocks, linear regulators, switch-mode regulator, Aux-ADC, LED driver and Lithium-ion/Polymer battery charger.

#### **6.12.1 3V1\_LDO**

The IS1681S has build-in the programmable output voltage LDOs (1.8~3.2V) for codec and digital IO power supply. The programmable LDO is used to regulate the high input voltage from battery or adapter. This LDO needs 1uF bypass capacitor.

#### ***6.12.2 Buck regulator***

The built-in programmable output voltage buck (1.8~2.4V) converts battery voltage for RF and baseband core power supply. This converter has high conversion efficiency and fast

transient response.

#### **6.12.3 Aux-ADC**

The 10-bit Successive-Approximation analog to digital converter (SAR ADC) monitors the battery power and adapter power for charging and power management control.

#### **6.12.4 Li-ion Battery Charger**

IS1681S includes a built-in battery charger optimized for use with lithium polymer batteries. The charger features a current sensor for charging control, user programmable current regulation and high accuracy voltage regulation. It charges the battery in four phases:

- reviving mode : 2mA charging current to charge BAT to 2.5V
- pre-charge mode : 0.1C charging current to charge BAT to 3.0V
- constant current mode : 0.xC (default 0.7C) charging current to charge BAT to 4.2V (programmable)
- constant voltage mode : charging is terminated while the charging current drops below 0.YC (default 0.13C)

Charging current in the constant current mode can be configured to provide a wide range of charging current up to 180mA (1mA per step). Charger will re-start charging if the battery voltage falls below an internal threshold.

System operation is allowed when the battery is charging.

#### **6.13 Miscellaneous (Watchdog Timer, and Clock Divider)**

System related functions such as watchdog timer, Endian control, and interrupt vectors are

also provided. The purpose of the watchdog timer is to provide a reset to CPU in case when the CPU fails to service the watchdog timer in a pre-defined (programmable) period.

## 7 Electrical Characteristics

### Absolute Maximum Ratings

| Rating                |  | Min   | Max   | Max |
|-----------------------|--|-------|-------|-----|
| Operation Temperature |  | -40°C | +85°C | °C  |
| Core supply voltage   | VDD_CORE, VCC_RF,<br>AVDD_SAR,<br>AVDD_PLL | 1.7V  | 1.98V | V   |
| Codec supply voltage  | VDD_AUDIO                                  |       | 3.3   | V   |
| I/O voltage           | VDD_IO                                     |       | 3.3   | V   |
| Supply voltage        | BK_VDD                                     |       | 4.7   | V   |
|                       | 3V1_VIN                                    |       | 5     | V   |
|                       | BAT_IN                                     |       | 4.3   | V   |
|                       | ADAP_IN                                    |       | 6     | V   |
|                       | LED[1:0]                                   |       | 5     | V   |
|                       | Power switch                               |       | 6     | V   |

### Recommended Operate Condition

| Symbol          | Parameter                   | Min  | Typical | Max  | Unit |
|-----------------|-----------------------------|------|---------|------|------|
| $V_{DD18}$      | Digital core supply voltage |      |         |      |      |
|                 | SAR ADC supply voltage      | 1.62 | 1.8     | 1.92 | V    |
|                 | CODEC supply voltage        |      |         |      |      |
| $V_{DDIO}$      | I/O supply voltage          | 2.5  | 2.7     | 3.3  | V    |
|                 | RF supply voltage           |      |         |      |      |
| $T_{OPERATION}$ | Operating temperature range | -20  | +25     | +70  | °C   |
| $T_{stg}$       | Storage temperature         | -40  |         | +125 | °C   |
| $V_{LDO}$       | LDO supply voltage          | 1.8  |         | 3.3  | V    |
| $V_{BAT\_IN}$   | Input voltage for SAR ADC   | 0.9  |         | 3.3  | V    |

## Radio Characteristics:

### Transmitter section for BDR

| VCC_RF = 2.7V<br>Temperature =<br>25°C                                 |                           | Min  | Typ | Max | Bluetooth<br>specification      | Unit         |
|--|---------------------------|------|-----|-----|---------------------------------|--------------|
| Maximum RF transmit power  |                           |      | 3   | 4.0 | -6 to 4                         | dBm          |
| RF power variation over temperature<br>range with compensation enabled |                           |      | ±2  |     |                                 | dB           |
| RF power control range   |                           |      | 20  |     | ≥16                             | dB           |
| RF power range control resolution                                      |                           |      | 0.5 |     |                                 | dB           |
| 20dB bandwidth for modulated carrier                                   |                           |      | 900 |     | ≤1000                           | KHz          |
| ACP  | F = F <sub>0</sub> ±2MHz  |      | -28 |     | ≤-20                            | dBm          |
|  | F = F <sub>0</sub> ±3MHz  |      | -46 |     | ≤-40                            | dBm          |
| Note:<br>F <sub>0</sub> =2441MHz                                       | F = F <sub>0</sub> ±>3MHz |      | -54 |     | ≤-40                            | dBm          |
| Δf <sub>1avg</sub> maximum modulation                                  |                           | 150  |     | 165 | 140<Δf <sub>1avg</sub> <17<br>5 | KHz          |
| Δf <sub>2max</sub> maximum modulation                                  |                           | 140  |     | 150 | ≥115                            | KHz          |
| Δf <sub>2avg</sub> /Δf <sub>1avg</sub>                                 |                           | 0.95 | 1   |     | ≥0.80                           |              |
| ICFT (abs)   |                           | 0    | 5   | 10  | 75                              | KHz          |
| Drift rate (abs)   |                           | 2    |     | 7   | ≤20                             | KHz/50u<br>s |
| Drift (single slot packet, abs)  |                           |      | 12  |     | ≤25                             | KHz          |
| 2 <sup>nd</sup> harmonic content @ Tx= 4dBm                            |                           |      | -53 |     | ≤-47                            | dBm          |
| 3 <sup>rd</sup> harmonic content @ Tx= 4dBm                            |                           |      | -55 |     | ≤-47                            | dBm          |

## Receiver section for BDR

| Temperature = 25°C   | Frequency (GHz)        | Min | Typ | Max | Bluetooth specification | Unit |
|--|------------------------|-----|-----|-----|-------------------------|------|
| Sensitivity at 0.1% BER for all basic rate packet types            | 2.402                  |     | -91 |     | ≤-70                    | dBm  |
|  | 2.441                  |     | -91 |     |                         |      |
|  | 2.480                  |     | -91 |     |                         |      |
| Maximum received signal at 0.1% BER                                |                        |     | -10 |     | ≥-20                    | dBm  |
| C/I co-channel   |                        |     | 5   |     | ≤11                     | dB   |
| Adjacent channel selectivity C/I<br><br>Note: $F_0=2441\text{MHz}$ | $F = F_0+1\text{MHz}$  |     | -7  |     | ≤0                      | dB   |
|  | $F = F_0-1\text{MHz}$  |     | -7  |     | ≤0                      | dB   |
|  | $F = F_0+2\text{MHz}$  |     | -36 |     | ≤-30                    | dB   |
|  | $F = F_0-2\text{MHz}$  |     | -22 |     | ≤-9                     | dB   |
|  | $F = F_0-3\text{MHz}$  |     | -24 |     | ≤-20                    | dB   |
|  | $F = F_0+5\text{MHz}$  |     | -50 |     | ≤-40                    | dB   |
|  | $F = F_{\text{image}}$ |     | -22 |     | ≤-9                     | dB   |
| Maximum level of intermodulation interferers                       |                        |     | -38 |     | ≥-39                    | dB   |

## Transmitter Section for EDR

| Temperature = 25°C                            |  | Min | Typ  | Max | Bluetooth specification  | Unit |
|---|--|-----|------|-----|--------------------------|------|
| Relative transmit power                       |  |     | -1.6 |     | -4 to 1                  | dB   |
| $\pi/4$ DQPSK max carrier frequency stability | $ \omega_o $<br>freq. error                  |     | 5    |     | $\leq 10$ for all blocks | KHz  |
|   | $ \omega_i $<br>initial freq. error          |     | 10   |     | $\leq 75$ for all blocks | KHz  |
|   | $ \omega_o + \omega_i $<br>block freq. error |     | 10   |     | $\leq 75$ for all blocks | KHz  |
| 8DPSK max carrier frequency stability         | $ \omega_o $<br>freq. error                  |     | 5    |     | $\leq 10$ for all blocks | KHz  |
|   | $ \omega_i $<br>initial freq. error          |     | 10   |     | $\leq 75$ for all blocks | KHz  |
|   | $ \omega_o + \omega_i $<br>block freq. error |     | 10   |     | $\leq 75$ for all blocks | KHz  |
| $\pi/4$ DQPSK modulation accuracy @ Tx= 2dBm  | RMS DEVM                                     |     | 7    |     | $\leq 20$                | %    |
|   | 99% DEVM                                     |     | Pass |     | $\leq 30$                | %    |
|   | Peak DEVM                                    |     |      | 25  | $\leq 35$                | %    |
| 8DQPSK modulation accuracy @ Tx= 2dBm         | RMS DEVM                                     |     | 7    |     | $\leq 13$                | %    |
|   | 99% DEVM                                     |     | Pass |     | $\leq 20$                | %    |
|   | Peak DEVM                                    |     |      | 20  | $\leq 25$                | %    |

|   |                       |  |      |  |           |              |
|---|-----------------------|--|------|--|-----------|--------------|
| In-band spurious<br>emissions<br><br>Note: $F_0=2441\text{MHz}$ | $F > F_0+3\text{MHz}$ |  | <-54 |  | $\leq-40$ | $\text{dBm}$ |
|   | $F = F_0-3\text{MHz}$ |  | -46  |  | $\leq-40$ | $\text{dBm}$ |
|   | $F = F_0-2\text{MHz}$ |  | -28  |  | $\leq-20$ | $\text{dBm}$ |
|   | $F = F_0-1\text{MHz}$ |  | -30  |  | $\leq-26$ | $\text{dBm}$ |
|   | $F = F_0+1\text{MHz}$ |  | -30  |  | $\leq-26$ | $\text{dBm}$ |
|   | $F = F_0+2\text{MHz}$ |  | -28  |  | $\leq-20$ | $\text{dBm}$ |
|   | $F = F_0+3\text{MHz}$ |  | -46  |  | $\leq-40$ | $\text{dBm}$ |
| EDR differential phase encoding                                 |                       |  | 100  |  | $\geq99$  | %            |

**Receiver Section for EDR**

| Temperature = 25°C  | Frequenc y (GHz)      | Modulatio n      | Min | Typ | Max | Bluetooth specificatio n | Unit |
|---|-----------------------|------------------|-----|-----|-----|--------------------------|------|
| Sensitivity at 0.01% BER  | 2.402                 | $\pi/4$<br>DQPSK |     | -92 |     | $\leq 70$                | dBm  |
|   | 2.441                 | $\pi/4$<br>DQPSK |     | -92 |     |                          |      |
|   | 2.480                 | $\pi/4$<br>DQPSK |     | -92 |     |                          |      |
|   | 2.402                 | 8DPSK            |     | -84 |     | $\leq 70$                | dBm  |
|   | 2.441                 | 8DPSK            |     | -84 |     |                          |      |
|   | 2.480                 | 8DPSK            |     | -84 |     |                          |      |
| Maximum received signal at 0.1% BER                                   |                       | $\pi/4$<br>DQPSK |     | -10 |     | $\geq -20$               | dBm  |
|   |                       | 8DPSK            |     | -10 |     | $\geq -20$               |      |
| C/I co-channel at 0.1% BER  |                       | $\pi/4$<br>DQPSK |     | 4   |     | $\leq 13$                | dB   |
|   |                       | 8DPSK            |     | 5   |     | $\leq 21$                | dB   |
| Adjacent channel selectivity C/I<br><br>Note:<br>$F_0=2441\text{MHz}$ | $F = F_0+1\text{MHz}$ | $\pi/4$<br>DQPSK |     | -14 |     | $\leq 0$                 | dB   |
|   |                       | 8DPSK            |     | -8  |     | $\leq 5$                 | dB   |
|   | $F = F_0-1\text{MHz}$ | $\pi/4$<br>DQPSK |     | -13 |     | $\leq 0$                 | dB   |
|   |                       | 8DPSK            |     | -8  |     | $\leq 5$                 | dB   |
|   | $F = F_0+2\text{MHz}$ | $\pi/4$<br>DQPSK |     | -38 |     | $\leq -30$               | dB   |
|   |                       | 8DPSK            |     | -34 |     | $\leq -25$               | dB   |
|   | $F = F_0-2\text{MHz}$ | $\pi/4$<br>DQPSK |     | -21 |     | $\leq -7$                | dB   |

|                         |         |       |  |     |  |            |    |
|-------------------------|---------|-------|--|-----|--|------------|----|
|                         |         | 8DPSK |  | -21 |  | $\leq 0$   | dB |
| $F = F_0 - 3\text{MHz}$ | $\pi/4$ |       |  | -27 |  | $\leq -20$ | dB |
|                         | DQPSK   |       |  |     |  |            |    |
| $F = F_0 + 5\text{MHz}$ | $\pi/4$ |       |  | -20 |  | $\leq -13$ | dB |
|                         | DQPSK   |       |  |     |  |            |    |
| $F = F_{\text{image}}$  | $\pi/4$ |       |  | -52 |  | $\leq -40$ | dB |
|                         | DQPSK   |       |  |     |  |            |    |
|                         | $\pi/4$ |       |  | -45 |  | $\leq -33$ | dB |
|                         | DQPSK   |       |  |     |  |            |    |
|                         | $\pi/4$ |       |  | -21 |  | $\leq -7$  | dB |
|                         | DQPSK   |       |  |     |  |            |    |
|                         | 8DPSK   |       |  | -21 |  | $\leq 0$   | dB |
|                         |         |       |  |     |  |            |    |

**Audio Codec: ADC**

| Test Condition:   |  |  |                            |      |      |
|---|--|--|----------------------------|------|------|
| T= 25°C, Vdd=2.8V, 1KHz sine wave input, Bandwidth = 20~20KHz |  |  |                            |      |      |
| Parameter   | Condition  | Min.                                       | Typ.                       | Max. | Unit |
| <b>Input full-scale</b>                                       | Full scale (line-in)   |  |                            | 2.2  | Vpp  |
| <b>Resolution</b>   |  |  | 16                         |      | bits |
| <b>Input Sampling Rate</b>                                    |  | 8  |                            | 48   | kHz  |
| <b>SNR</b>  | f <sub>in</sub> =1KHz<br>B/W=20~20KHz<br>A-weighted<br>THD+N < 1%<br>150mVpp input | 8KHz<br>16KHz<br>32KHz<br>44.1KHz<br>48KHz | 83<br>83<br>83<br>83<br>83 |      | dB   |
| <b>SNR</b>  | A-weighted 1KHz@full scale,<br>Microphone boost enable                             |  | 75                         |      | dB   |
| <b>THD+N</b> (Mic input)<br>@30mVrms input                    |  |  | 0.04                       |      | %    |
| <b>THD+N</b> (line input)                                     |  |  | 0.01                       |      | %    |
| <b>Mic Boost Gain</b>   |  |  | 20                         |      | dB   |
| <b>Digital Gain</b>   |  | -54  |                            | 4.85 | dB   |
| <b>Analog Gain</b>  |  |  |                            | 26   | dB   |
| <b>Digital Gain Step</b>                                      |  |  | 6                          |      | dB   |
| <b>Analog Gain Step</b>                                       |  |  | 1.7                        |      | dB   |
| <b>Input impedance</b><br>(microphone mode)                   | Input impedance  |  | 6                          | 10   | KΩ   |
|   | Input capacitance  |  |                            | 20   | pF   |
| <b>Analog supply voltage<br/>(AVDD)</b>                       |  | 1.8  | 2.8                        | 3.0  | V    |

**Audio Codec: DAC**

| Test Condition: T= 25°C, Vdd=2.8V, 1KHz sine wave input, Bandwidth= 20~20KHz |   |      |      |      |      |
|--|---|------|------|------|------|
| Parameter  | Condition   | Min. | Typ. | Max. | Unit |
| <b>Output Level</b>  | Full scale  |      | 2.1  |      | Vpp  |
| <b>Resolution</b>  |   | 16   |      |      | bits |
| <b>Output Sampling Rate</b>  |   | 8    |      | 48   | KHz  |
| <b>SNR</b>   | $f_{in}=1\text{KHz}$<br>B/W=20~20KHz<br>A-weighted<br>THD+N < 0.01%<br>0dBFS signal<br>Load=100KΩ | 8KHz |      | 94   | dB   |
|  | 16KHz   |      | 94   |      | dB   |
|  | 32KHz   |      | 94   |      | dB   |
|  | 44.1KHz   |      | 94   |      | dB   |
|  | 48KHz   |      | 94   |      | dB   |
|  |   |      |      |      |      |
| <b>Max Output Power</b>  | $R_L=16\text{Ohm}$  |      | 35   |      | mW   |
|  | $R_L=32\text{Ohm}$  |      | 17   |      | mW   |
| <b>THD+N</b>   | 16Ohm load  |      |      | 0.05 | %    |
|  | 100KΩ load  |      |      | 0.01 | %    |
| <b>Digital Gain</b>  |   | -54  |      | 4.85 | dB   |
| <b>Digital Gain Resolution</b>   |   |      | 6    |      | dB   |
| <b>Analog Gain</b>   |   | -28  |      | 3    | dB   |
| <b>Analog Gain step</b>  |   |      | 1    |      | dB   |
| <b>Output resistance</b>   | $R_L$   | 8    | 16   |      | Ohm  |
| <b>Output capacitance</b>  | $C_p$   |      |      | 500  | pF   |
| <b>Crosstalk between channels</b>  | L vs. R, measured at -10dBFS@1KHz input   |      | -90  | -80  | dB   |
| <b>Analog supply voltage (AVDD)</b>  |   | 1.8  | 2.8  | 3.0  | V    |

**Battery Charger**

| Charging Mode (BAT_IN rising to 4.2V)   | Min             | Typ   | Max | Unit |
|---|-----------------|-------|-----|------|
| <b>Operation Temperature</b>  | -20             |       | 70  | °C   |
| <b>Input Voltage (Vin)</b><br><br>Note: It needs more time to get battery fully charged when Vin=4.5V | 4.5             |       | 6   | V    |
| <b>Battery trickle charge current</b><br>(BAT_IN < trickle charge voltage threshold)                  |                 | 0.1C  |     | mA   |
| <b>Trickle charge voltage threshold</b>   |                 | 3     |     | V    |
| <b>Maximum battery charge current</b>   | Headroom > 0.7V | 350   |     | mA   |
|   | Headroom = 0.3V | 150   |     | mA   |
| <b>Minimum battery charge current</b>   | Headroom > 0.7V | 1     |     | mA   |
|   | Headroom = 0.3V | 1     |     | mA   |
| <b>Battery charge termination current,</b><br>% of fast charge current                                |                 | 10    |     | %    |
| <b>Battery recharge hysteresis</b> (Note1)  |                 | 100   |     | mV   |
| <b>Battery recharge current</b> (Note2)<br><br>Note: C → Battery capacity                             |                 | 0.25C |     | mA   |

Note1 : When charging complete and the adapter is still in, the battery voltage will slowly drop down.

When the voltage drop is larger than 100mV from the full voltage, the re-charging cycle will start.

Note2 : If the battery voltage during plug in is larger than 4V, the charging current will be limited to 0.25C to avoid the battery voltage overshoot.

**Switching Regulator**

| Normal Operation                                   | Min                       | Typ  | Max | Unit  |
|--|---------------------------|------|-----|-------|
| <b>Operation Temperature</b>                       | -20                       |      | 70  | °C    |
| <b>Input Voltage (Vin)</b>                         | 3                         | 3.7  | 4.5 | V     |
| <b>Output Voltage (Vout)</b>                       | 1.6                       | 1.85 | 2.4 | mA    |
| <b>Output Ripple</b>                               |                           |      | 20  | mVrms |
| <b>Max. Average Load Current(I<sub>load</sub>)</b> | 120                       |      |     | mA    |
| <b>Max. Output Current (peak)</b>                  | 200                       |      |     | mA    |
| <b>Conversion Efficiency</b><br>(Bat.@3.7V)        | I <sub>load</sub> =50mA   | 88   |     | %     |
|  | I <sub>load</sub> ≥ 10mA  | 80   |     |       |
|  | I <sub>load</sub> ≥ 250uA | 65   |     |       |
| <b>Switching Frequency</b>                         |                           | 800  |     | KHz   |
| <b>Start-up current Limit</b>                      | 0                         | 50   | 210 | mA    |
| <b>Start-up Settling Time</b>                      |                           | 1.2  | 2   | ms    |
| <b>Shutdown Current</b>                            |                           |      | <1  | uA    |

**LDO**

| Normal Operation  |                                    | Min | Typ  | Max | Unit    |
|---|------------------------------------|-----|------|-----|---------|
| <b>Input Voltage (Vin)</b>  |                                    | 3.0 |      | 4.5 | V       |
| <b>Output Voltage (V<sub>OUT</sub>)</b>                               | V <sub>OUT</sub> = 2.9V (2.4~3.4V) |     | 2.9  |     | V       |
| (1) V <sub>OUT_CODEC</sub>  | V <sub>OUT</sub> = 1.8V (1.3~2.3V) |     | 1.8  |     |         |
| <b>Accuracy (V<sub>IN</sub>=3.7V, I<sub>LOAD</sub>=100mA, 27°C)</b>   |                                    |     | ±5   |     | %       |
| <b>Output Voltage adjustable step</b>                                 |                                    |     | 100  |     | mV/Step |
| <b>Output adjustment range</b>  |                                    |     | ±0.5 |     | V       |
| <b>Start-up inrush current</b>  |                                    | 200 | 400  |     | mA      |
| <b>Start-up Settling Time</b>   |                                    | 250 | 500  |     | μs      |
| <b>Output current(average)</b>  |                                    |     | 100  |     | mA      |
| <b>Output Current(peak)</b>   |                                    |     | 150  |     | mA      |
| <b>Drop-out voltage (I<sub>load</sub> = maximum output current)</b>   |                                    |     | 300  |     | mV      |
| <b>Quiescent Current</b><br>(excluding load, I <sub>load</sub> < 1mA) |                                    | 45  |      |     | μA      |
| <b>Load Regulation (I<sub>load</sub> = 0mA to 100mA), ΔVout</b>       |                                    |     | 80   |     | mV      |
| <b>Shutdown Current</b>   |                                    |     | <1   |     | μA      |

Note: Two 100mA LDOs, one for IO and one for audio CODEC.

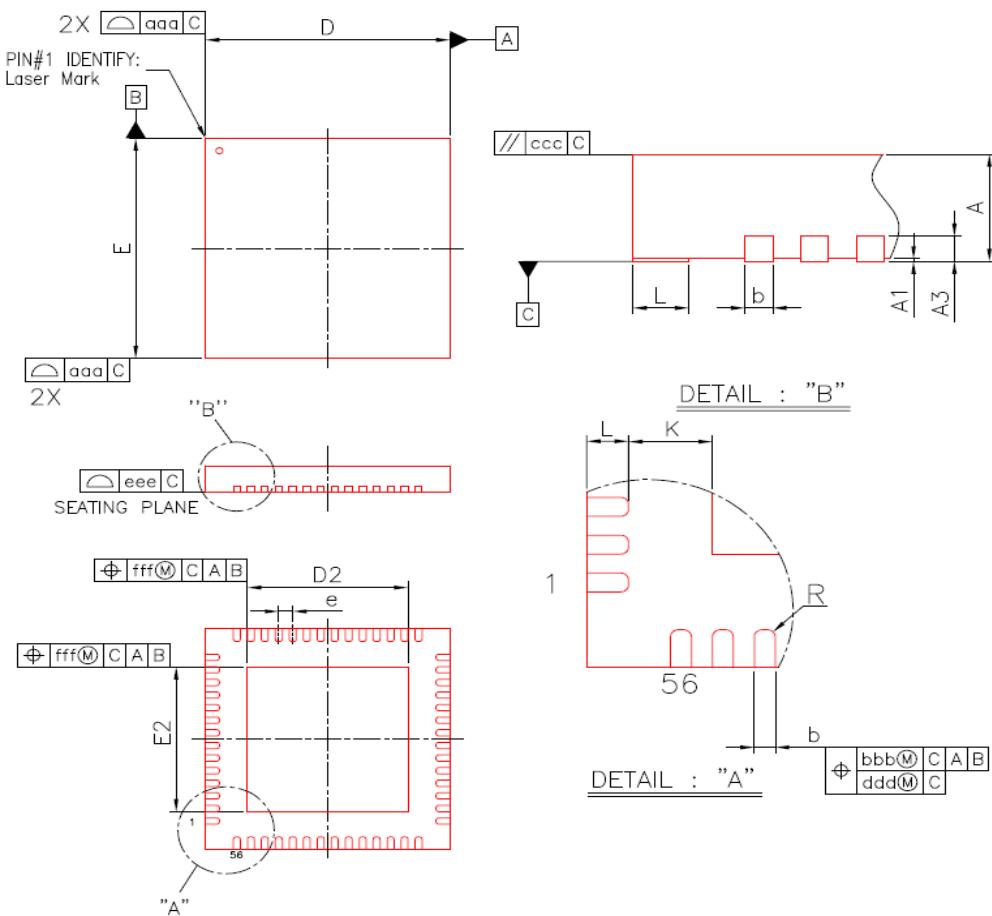
**Clock**

| Parameters            | MIN | TYP      | MAX | Unit |
|-----------------------|-----|----------|-----|------|
| Crystal Frequency     |     | 16       |     | MHz  |
| Frequency Tolerance   |     | $\pm 20$ |     | ppm  |
| Operating Temperature | -20 |          | 70  | °C   |
| Trimming Capacitance  |     | 6.4      |     | pF   |
| Trimming Step Size    |     | 0.2      |     | pF   |

**Digital GPIO (2.8V)**

| Parameters                            | MIN | TYP | MAX | Unit |
|---------------------------------------|-----|-----|-----|------|
| <b>Input Voltage</b>                  | 2.7 | 3   | 3.6 | V    |
| V <sub>IH</sub> (Input High Voltage)  | 2.0 |     | Vdd | V    |
| V <sub>IL</sub> (Input Low Voltage)   | 0   |     | 0.8 | V    |
| <b>Input Reference Resistor</b>       |     |     |     |      |
| R <sub>PU</sub> (Pull-Up Resistor)    |     | 50K |     | Ohm  |
| R <sub>PD</sub> (Pull-Down Resistor)  |     | 50K |     | Ohm  |
| <b>Output Voltage</b>                 |     |     |     |      |
| V <sub>OH</sub> (Output High Voltage) | 2.4 |     | Vdd | V    |
| V <sub>OL</sub> (Output Low Voltage)  | 0   |     | 0.4 | V    |

## 8 Package Information



| Symbol | Dimension in mm |      |           | Dimension in inch |       |       |
|--------|-----------------|------|-----------|-------------------|-------|-------|
|        | MIN             | NOM  | MAX       | MIN               | NOM   | MAX   |
| A      | 0.80            | 0.85 | 0.90      | 0.031             | 0.033 | 0.035 |
| A1     | 0.00            | 0.02 | 0.05      | 0.000             | 0.001 | 0.002 |
| A3     | 0.20 REF        |      | 0.008 REF |                   |       |       |
| b      | 0.15            | 0.20 | 0.25      | 0.006             | 0.008 | 0.010 |
| D      | 6.90            | 7.00 | 7.10      | 0.272             | 0.276 | 0.280 |
| E      | 6.90            | 7.00 | 7.10      | 0.272             | 0.276 | 0.280 |
| D2     | 4.45            | 4.60 | 4.75      | 0.175             | 0.181 | 0.187 |
| E2     | 4.45            | 4.60 | 4.75      | 0.175             | 0.181 | 0.187 |
| e      | 0.40 BSC        |      |           | 0.016 BSC         |       |       |
| L      | 0.30            | 0.40 | 0.50      | 0.012             | 0.016 | 0.020 |
| K      | 0.20            | ---  | ---       | 0.008             | ---   | ---   |
| R      | 0.075           | ---  | ---       | 0.003             | ---   | ---   |
| aaa    | 0.10            |      |           | 0.004             |       |       |
| bbb    | 0.07            |      |           | 0.003             |       |       |
| ccc    | 0.10            |      |           | 0.004             |       |       |
| ddd    | 0.05            |      |           | 0.002             |       |       |
| eee    | 0.08            |      |           | 0.003             |       |       |
| fff    | 0.10            |      |           | 0.004             |       |       |

NOTE:

1. CONTROLLING DIMENSION : MILLIMETER
2. REFERENCE DOCUMENT: JEDEC MO-220.

## Appendix A. Reflow Profile

1.) Follow: IPC/JEDEC J-STD-020 C

2.) Condition:

Average ramp-up rate (217°C to peak): 1~2°C/sec max.

Preheat : 150~200C 、 60~180 seconds

Temperature maintained above 217°C : 60~150 seconds

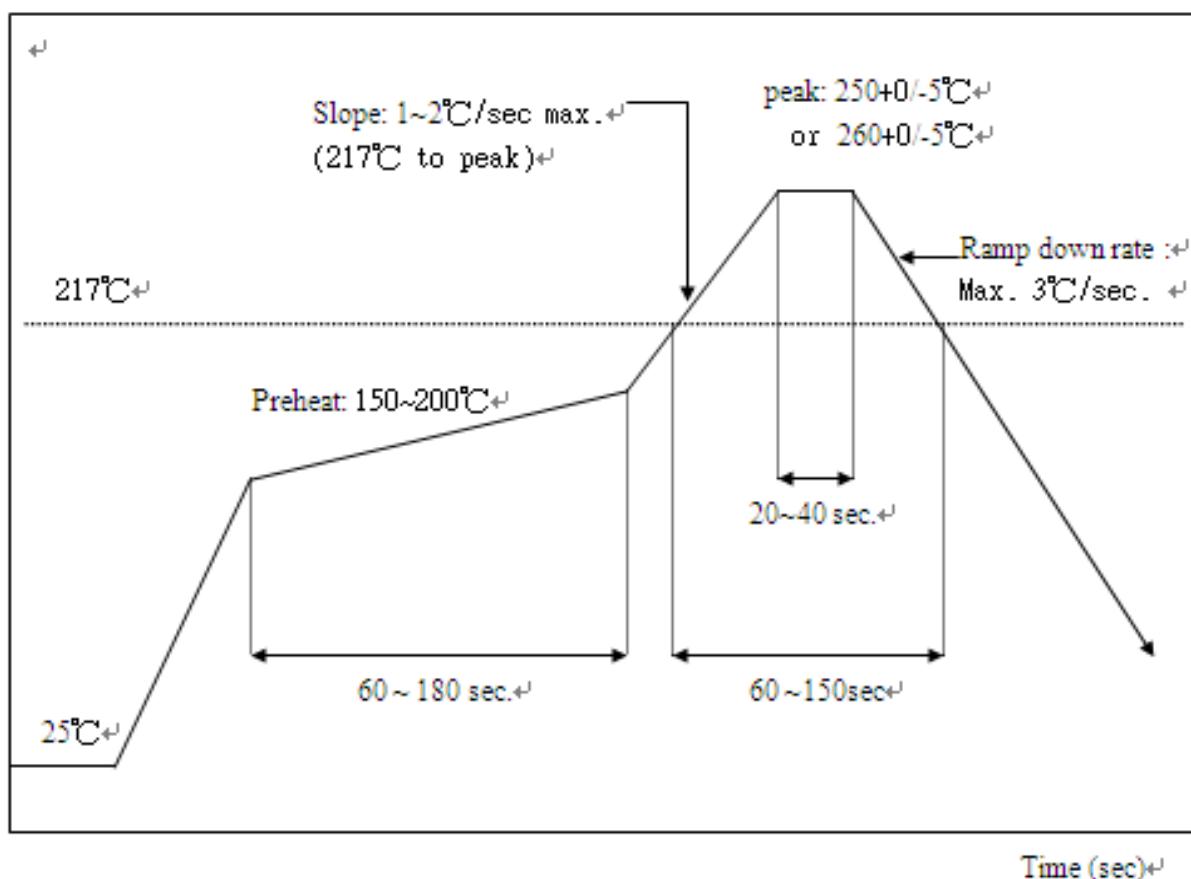
Time within 5°C of actual peak temperature: 20 ~ 40 sec.

Peak temperature : 250+0/-5°C or 260+0/-5°C

Ramp-down rate : 3°C/sec. max.

Time 25°C to peak temperature : 8 minutes max.

Cycle interval : 5 minus



## Appendix B. BQB certification

|  |  |      |                      |
|--|--|------|----------------------|
| TPG Project                                | ISSC Bluetooth 3.0+EDR Single Chip (Component (Tested))      |      |                      |
| Qualified Design ID (QD ID)                | B016749   <a href="#">Export PICS</a>                        |      |                      |
| PRD 1.0 ID (QP ID)                         |  |      |                      |
| Design Name                                | ISSC Bluetooth 3.0+EDR Single Chip                           |      |                      |
| Wi-Fi® Certification ID                    |  |      |                      |
| Subsetted Designs                          | Date Created   | Type | PICS                 |
|  | Jun 28, 2010   | Main | <a href="#">PICS</a> |
| Member Company                             | ISSC Technologies Corp.                                      |      |                      |
| Specification Name                         | 3.0  |      |                      |
| Core Spec Addenda                          | N/A  |      |                      |
| Design Model Number                        | IS1XYZ, where X, Y and Z means 1~9                           |      |                      |
| Hardware Version Number                    | ISBT_BB_v30  |      |                      |
| Software Version Number                    | ISBT_BB_v30  |      |                      |
| Qualification Assessment Date              | July/21/2010   |      |                      |
| Listing Date                               | July/21/2010   |      |                      |
| Design Description                         | ISSC Bluetooth 3.0+EDR Single Chip                           |      |                      |
| Product Type                               | Component (Tested)   |      |                      |
| <a href="#">Technical Data Sheet (RIN)</a> | ** <a href="#">Open Reference Integration Notes (RIN)</a> ** |      |                      |
| Listed By                                  | <a href="#">Charlie Lee</a>                                  |      |                      |
| BQE  | <a href="#">Jan-Willem Vonk</a>                              |      |                      |
| Profile / Protocol                         | Role / Version (If Any)                                      |      |                      |
| Baseband                                   |  |      |                      |
| Radio                                      |  |      |                      |
| Link Manager                               |  |      |                      |